



bestirpower

# BMB80N180C1

## N-Channel Power MOSFET

800V, 23A, 180mΩ

### Description

BMB80N180C1 is power MOSFET using bestirpower's advanced super junction technology that can realize very low on-resistance and gate charge. It will provide much high efficiency by using optimized charge coupling technology. These user friendly devices give an advantage of Low EMI to designers as well as low switching loss.

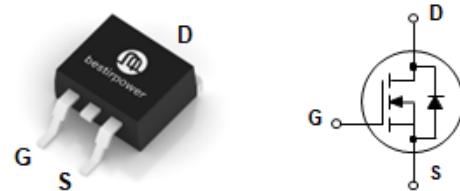
### Features

| $V_{DS} @ T_{J,max}$ | $I_D$ | $R_{DS(on),max}$ | $Q_{g,typ}$ |
|----------------------|-------|------------------|-------------|
| 850V                 | 23 A  | 180 mΩ           | 56nC        |

- Ultra-fast body diode.
- Extremely low losses due to very low FOM.
- Very high commutation ruggedness.
- Halogen Free, and RoHS Compliant

### Applications

- PC power
- Server power supply
- Telecom
- LED lighting
- EV Charger
- Solar/UPS



### Absolute Maximum Ratings ( $T_c = 25^\circ\text{C}$ unless otherwise noted)

| Symbol         | Parameter  |  | Value      | Unit |
|----------------|--|--|------------|------|
| $V_{DSS}$      | Drain to Source Voltage <sup>1)</sup>                                    |  | 800        | V    |
| $V_{GSS}$      | Gate to Source Voltage   |  | $\pm 30$   | V    |
| $I_D$          | Drain Current <sup>2)</sup>  | Continuous ( $T_c = 25^\circ\text{C}$ )  | 23         | A    |
|                |  | Continuous ( $T_c = 125^\circ\text{C}$ ) | 10         |      |
| $I_{DM}$       | Drain Current  | Pulsed                                   | 70         | A    |
| $E_{AS}$       | Single Pulsed Avalanche Energy   |  | 845        | mJ   |
| $I_{AR}$       | Repetitive Avalanche Energy  |  | 13         | A    |
| $dv/dt$        | MOSFET $dv/dt$ ruggedness  |  | 50         | V/ns |
|                | Diode Recovery $dv/dt$ ruggedness  |  | 50         |      |
| $P_D$          | Power Dissipation  | ( $T_c = 25^\circ\text{C}$ )             | 250        | W    |
| $T_J, T_{STG}$ | Storage Temperature Range  |  | -55 to 150 | °C   |
| $T_L$          | Maximum Lead Temperature for Soldering,<br>1/8" from Case for 10 Seconds |  | 260        | °C   |

### Thermal Characteristics

| Symbol   | Parameter  | Value | Unit |
|----------|--|-------|------|
| $R_{ac}$ | Thermal Resistance, Junction to Case, Max.                       | 0.5   | °C/W |
| $R_{aj}$ | Thermal Resistance, Junction to Ambient, Max. *minimal footprint | 62.5  |      |

## Package Marking and Ordering Information

| Part Number | Top Marking | Package  | Packing Method | Quantity  |
|-------------|-------------|----------|----------------|-----------|
| BMB80N180C1 | BMB80N180C1 | TO263-2L | Tape & Reel    | 800 units |

## Electrical Characteristics (T<sub>C</sub> = 25°C unless otherwise noted)

| Symbol                     | Parameter                         | Test Conditions   | Min | Typ | Max  | Unit |
|----------------------------|-----------------------------------|---|-----|-----|------|------|
| <b>Off Characteristics</b> |                                   |   |     |     |      |      |
| BV <sub>DSS</sub>          | Drain to Source Breakdown Voltage | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250µA                       | 800 | -   | -    | V    |
| I <sub>DSS</sub>           | Zero Gate Voltage Drain Current   | V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V T <sub>j</sub> =25°C | -   | -   | 10   | µA   |
| I <sub>GSS</sub>           | Gate-Source Leakage Current       | V <sub>GS</sub> = ±30 V, V <sub>DS</sub> = 0 V                      | -   | -   | ±100 | nA   |

## On Characteristics

|                     |                                      |  |     |     |     |    |
|---------------------|--------------------------------------|--|-----|-----|-----|----|
| V <sub>GS(th)</sub> | Gate Threshold Voltage               | V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250µA         | 2.5 | 3.5 | 4.5 | V  |
| R <sub>DS(on)</sub> | Static Drain to Source On Resistance | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12A, T <sub>j</sub> =25°C | -   | 150 | 180 | mΩ |

## Dynamic Characteristics

|                      |                                   |  |   |      |   |    |
|----------------------|-----------------------------------|--|---|------|---|----|
| C <sub>iss</sub>     | Input Capacitance                 | V <sub>GS</sub> =0V, V <sub>DS</sub> =100V, f=250KHz                       | - | 2440 | - | pF |
| C <sub>oss</sub>     | Output Capacitance                |  | - | 83   | - | pF |
| C <sub>rss</sub>     | Reverse Transfer Capacitance      |  | - | 1.9  | - | pF |
| C <sub>o(er)</sub>   | Energy Related Output Capacitance | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V to 500 V                        | - | 66   | - | pF |
| C <sub>o(tr)</sub>   | Time Related Output Capacitance   | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V to 500 V                        | - | 214  | - | pF |
| Q <sub>g</sub>       | Total Gate Charge                 | V <sub>GS</sub> = 0 - 10V,<br>V <sub>DD</sub> = 640V, I <sub>D</sub> = 24A | - | 56   | - | nC |
| Q <sub>gs</sub>      | Gate to Source Charge             |  | - | 15   | - | nC |
| Q <sub>gd</sub>      | Gate to Drain "Miller" Charge     |  | - | 21   | - | nC |
| V <sub>plateau</sub> | Gate plateau voltage              |  | - | 5.5  | - | V  |
| R <sub>G</sub>       | Gate Resistance                   | V <sub>DD</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz                     | - | 4    | - | Ω  |

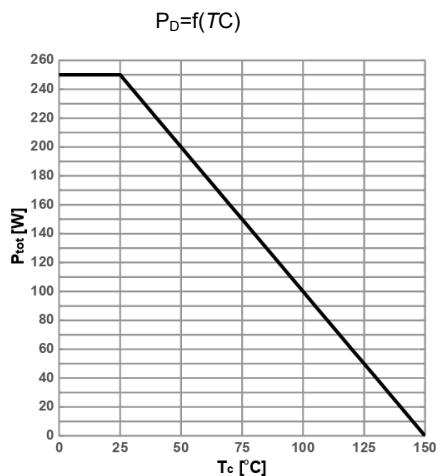
## Switching Characteristics

|                     |                     |   |   |     |   |    |
|---------------------|---------------------|---|---|-----|---|----|
| t <sub>d(on)</sub>  | Turn-On Delay Time  | V <sub>GS</sub> = 10V, V <sub>DD</sub> = 400V, I <sub>D</sub> = 12A | - | 20  | - | ns |
| t <sub>r</sub>      | Turn-On Rise Time   |   | - | 13  | - | ns |
| t <sub>d(off)</sub> | Turn-Off Delay Time |   | - | 117 | - | ns |
| t <sub>f</sub>      | Turn-Off Fall Time  |   | - | 12  | - | ns |

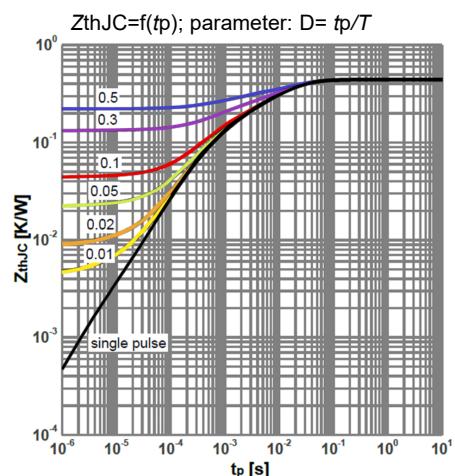
## Reverse Diode Characteristics

|                  |                                  |   |   |     |    |    |
|------------------|----------------------------------|---|---|-----|----|----|
| I <sub>SD</sub>  | Continuous Diode Forward Current | V <sub>R</sub> = 60V<br>I <sub>F</sub> = 24A<br>dI <sub>F</sub> /dt = 100A/µs | - | -   | 23 | A  |
| V <sub>SD</sub>  | Diode Forward Voltage            |   | - | 0.8 | -  | V  |
| t <sub>rr</sub>  | Reverse Recovery Time            |   | - | 375 | -  | ns |
| Q <sub>rr</sub>  | Reverse Recovery Charge          |   | - | 6.7 | -  | µC |
| I <sub>rrm</sub> | Reverse Recovery Current         |   | - | 29  | -  | A  |

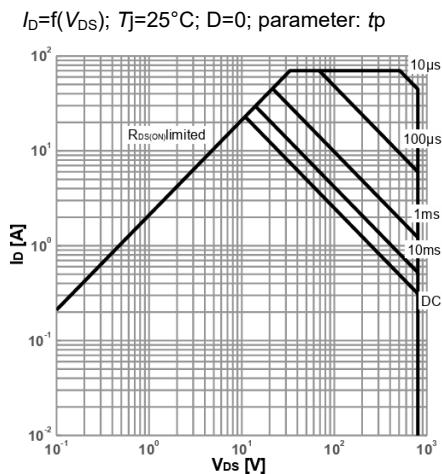
**Figure 1. Power dissipation**



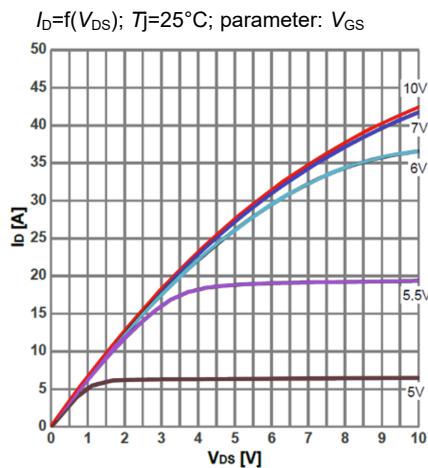
**Figure 2. Max. transient thermal impedance**



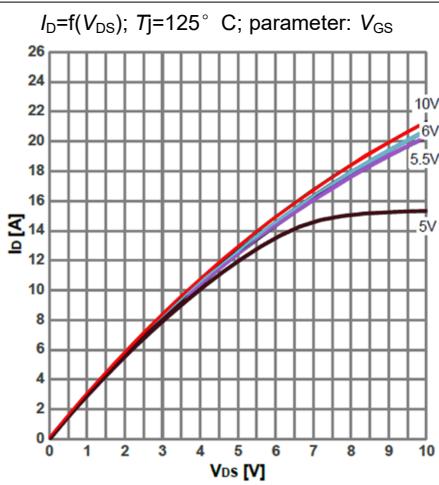
**Diagram 3: Safe operating area**



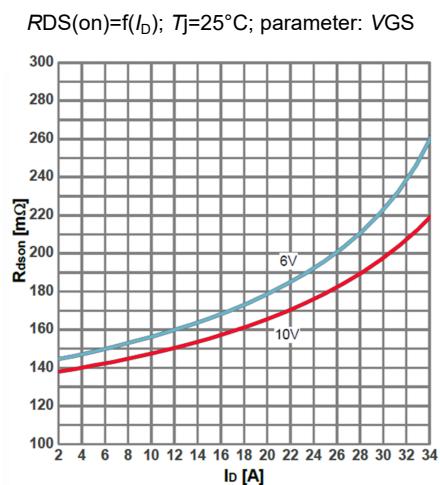
**Figure 4: Typ. output characteristics**



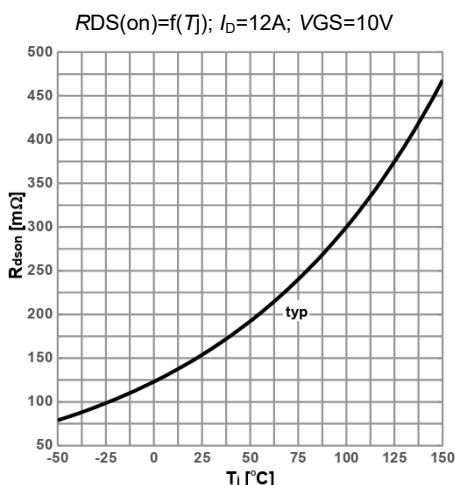
**Figure 5: Typ. output characteristics**



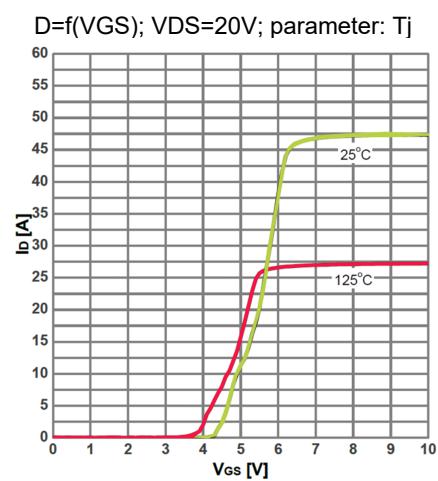
**Figure 6: Typ. drain-source on-state resistance**



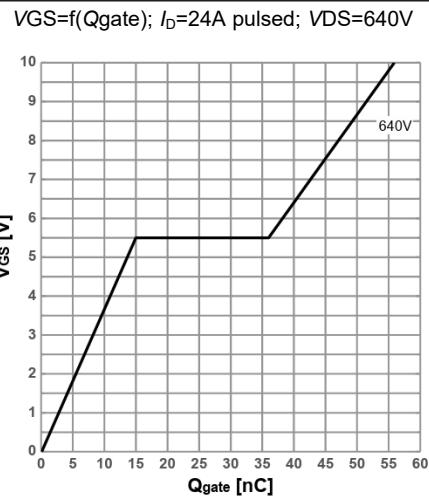
**Figure 7: drain-source on-state resistance**



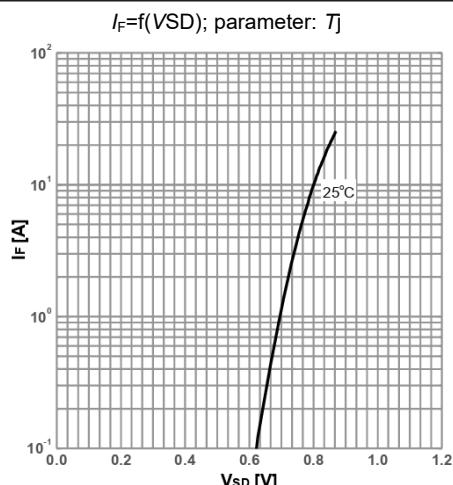
**Figure 8: Typ. transfer characteristics**



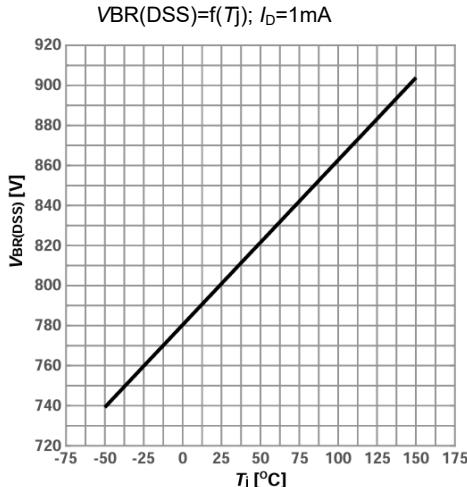
**Figure 9:Typ. gate charge**



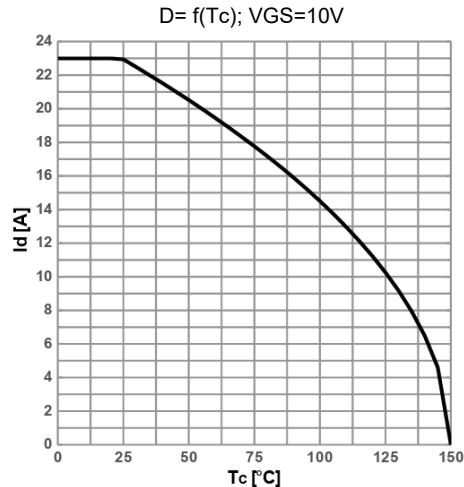
**Figure10:Forward characteristics of reverse diode**



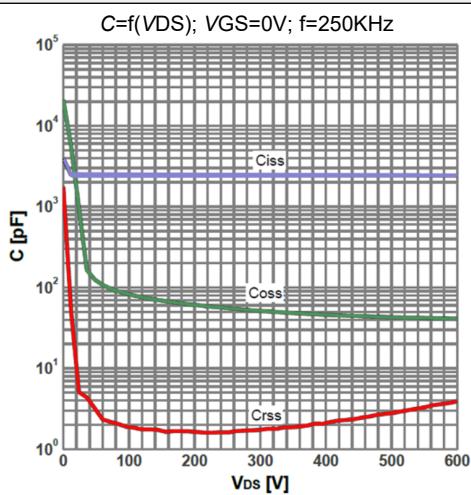
**Figure11:Drain-source breakdown voltage**



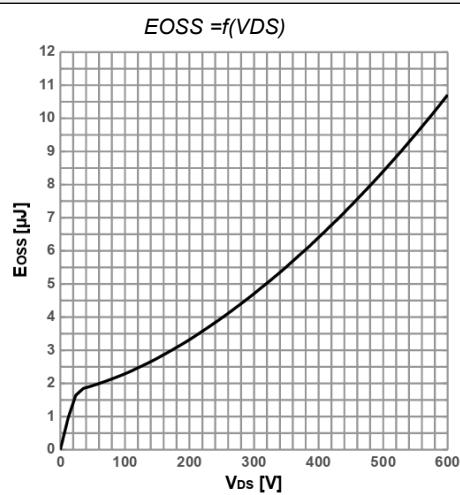
**Figure12:Maximum Drain Current**



**Figure13:Typ. capacitances**



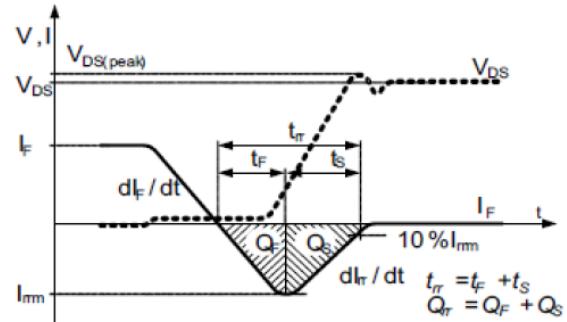
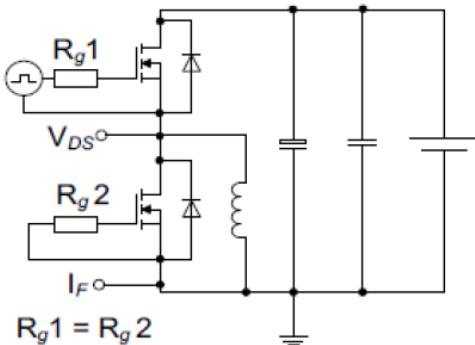
**Figure14:Typ. Coss stored energy**



## Test Circuits

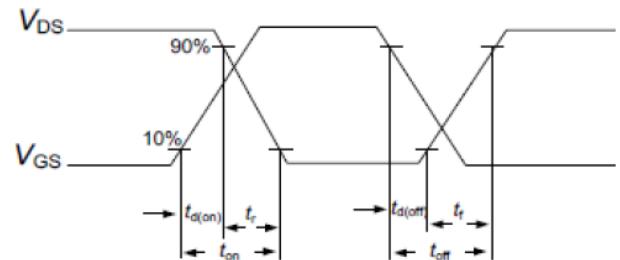
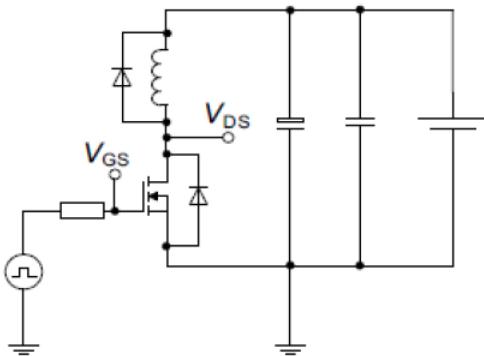
**Figure15:Diode Characteristics**

Test circuit for diode characteristics and Diode recovery waveform



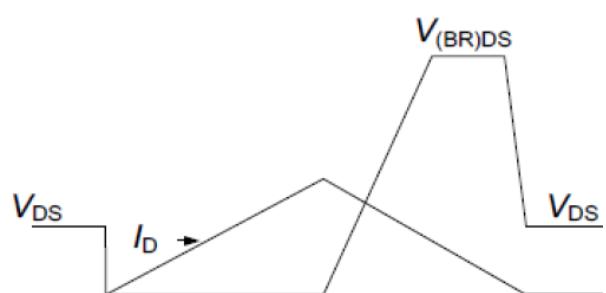
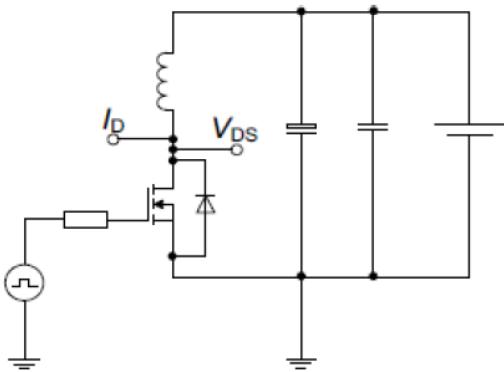
**Figure16:Switching Times**

Switching times test circuit for inductive load and Switching times waveform



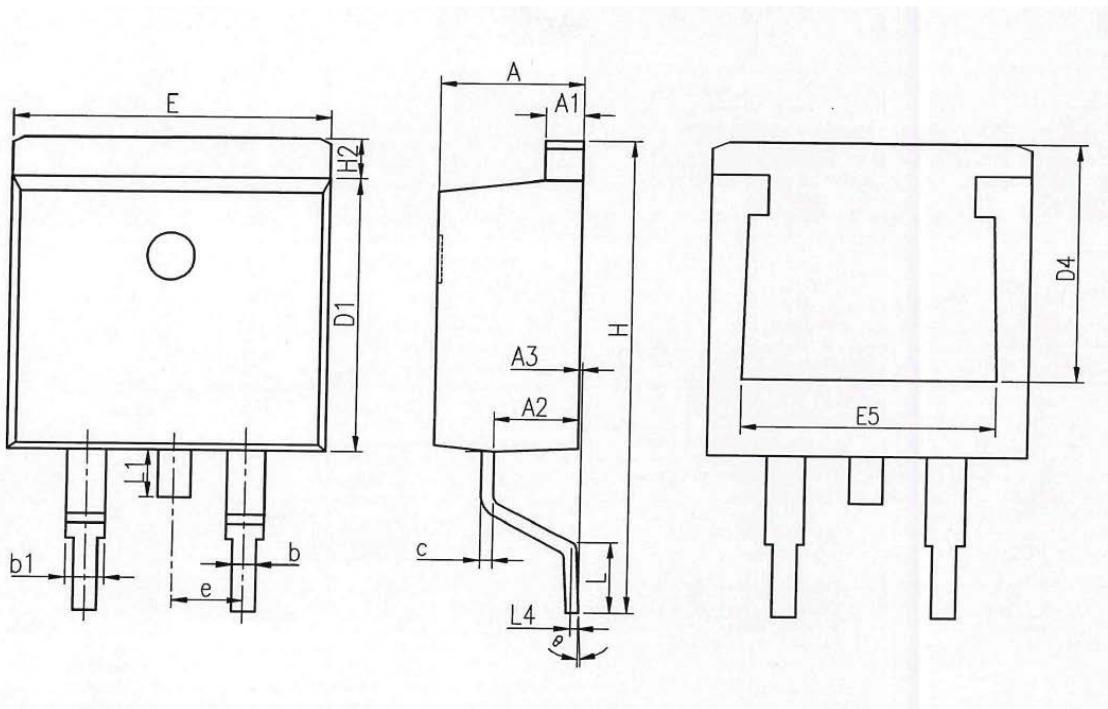
**Figure17:Unclamped Inductive Load**

Unclamped inductive load test circuit and Unclamped inductive waveform



## Package Outlines

# TO263-2L



## COMMON DIMENSIONS

| SYMBOL | MM       |       |       |
|--------|----------|-------|-------|
|        | MIN      | NOM   | MAX   |
| A      | 4.37     | 4.57  | 4.77  |
| A1     | 1.22     | 1.27  | 1.42  |
| A2     | 2.49     | 2.69  | 2.89  |
| A3     | 0.00     | 0.13  | 0.25  |
| b      | 0.70     | 0.81  | 0.96  |
| b1     | 1.17     | 1.27  | 1.47  |
| c      | 0.30     | 0.38  | 0.53  |
| D1     | 8.50     | 8.70  | 8.90  |
| D4     | 6.60     | -     | -     |
| E      | 9.86     | 10.16 | 10.36 |
| E5     | 7.06     | -     | -     |
| e      | 2.54 BSC |       |       |
| H      | 14.70    | 15.10 | 15.50 |
| H2     | 1.07     | 1.27  | 1.47  |
| L      | 2.00     | 2.30  | 2.60  |
| L1     | 1.40     | 1.55  | 1.70  |
| L4     | 0.25 BSC |       |       |
| θ      | 0°       | 5°    | 9°    |

\* Dimensions in millimeters

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